

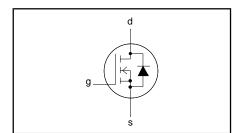
N-channel TrenchMOSTM transistor

PSMN057-200B

FEATURES

- 'Trench' technology
- Very low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

$$V_{DSS}$$
 = 200 V I_{D} = 39 A $R_{DS(ON)} \le 57 \text{ m}\Omega$

GENERAL DESCRIPTION

SiliconMAX products use the latest Philips Trench technology to achieve the lowest possible on-state resistance in each package at each voltage rating.

Applications:-

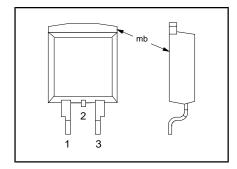
- d.c. to d.c. converters
- switched mode power supplies

The PSMN057-200B is supplied in the SOT404 (D²PAK) surface mounted package.

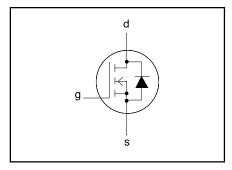
PINNING - SOT404

PIN	DESCRIPTION	
1	gate	
2	drain (no connection possible)	
3	source	
mb	drain	

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
	Drain-source voltage	T _i = 25 °C to 175 °C	-	200	V
V_{DGR}	Drain-gate voltage	$T_i = 25 ^{\circ}\text{C} \text{ to } 175 ^{\circ}\text{C}; R_{GS} = 20 \text{k}\Omega$	-	200	V
	Gate-source voltage	,	-	± 20	V
I _D	Continuous drain current	$T_{mb} = 25 ^{\circ}C$	-	39	Α
		$T_{mb} = 100 ^{\circ}C$	-	27.5	Α
I _{DM}	Pulsed drain current	$T_{mb} = 25 ^{\circ}C$	-	156	Α
P_{D}	Total power dissipation	$T_{mb} = 25 ^{\circ}C$	-	250	W
T_{j} , T_{stg}	Operating junction and		- 55	175	°C
	storage temperature				

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AVALANCHE ENERGY LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
7.0	energy	Unclamped inductive load, $I_{AS} = 35 \text{ A}$; $t_p = 100 \mu\text{s}$; $T_j \text{ prior to avalanche} = 25 ^{\circ}\text{C}$; $V_{DD} \le 50 \text{ V}$; $R_{GS} = 50 \Omega$; $V_{GS} = 10 \text{ V}$;	-	300	mJ
7.0	Non-repetitive avalanche current		-	35	Α

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R _{th j-mb}	Thermal resistance junction		-	0.6	K/W
R _{th j-a}	to mounting base Thermal resistance junction to ambient	Minimum footprint, FR4 board	50	-	K/W

ELECTRICAL CHARACTERISTICS

T_i= 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA};$ $T_i = -55 ^{\circ}\text{C}$	200 178	-	-	V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$; $I_{D} = 1 \text{ mA}$	2.0	3.0	4.0	V
		$T_j = 175^{\circ}C$ $T_i = -55^{\circ}C$	1.0	-	- 6	V
$R_{DS(ON)}$	Drain-source on-state	$V_{GS} = 10 \text{ V}; I_{D} = 17 \text{ A}$	-	41	57	mΩ
I _{GSS}	resistance Gate source leakage current	$V_{GS} = \pm 10 \text{ V}; V_{DS} = 0 \text{ V}$	-	2	165 100	mΩ nA
I _{DSS}	Zero gate voltage drain current	$V_{DS} = 200 \text{ V}; V_{GS} = 0 \text{ V};$ $T_{i} = 175^{\circ}\text{C}$	-	0.03	10 500	μA μA
$\begin{matrix} Q_{g(tot)} \\ Q_{gs} \\ Q_{gd} \end{matrix}$	Total gate charge Gate-source charge Gate-drain (Miller) charge	$I_D = 39 \text{ A}; V_{DD} = 160 \text{ V}; V_{GS} = 10 \text{ V}$	- - -	96 13 37	- - 50	nC nC nC
$egin{array}{l} t_{d\ on} \ t_r \ t_{d\ off} \ t_f \end{array}$	Turn-on delay time Turn-on rise time Turn-off delay time Turn-off fall time	V_{DD} = 100 V; R_{D} = 2.7 Ω ; V_{GS} = 10 V; R_{G} = 5.6 Ω Resistive load	- - -	18 58 105 78	- - -	ns ns ns ns
L _d L _s	Internal drain inductance Internal source inductance	Measured from tab to centre of die Measured from source lead to source bond pad	-	3.5 7.5	- -	nH nH
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Feedback capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$	- - -	3750 385 180	- - -	pF pF pF

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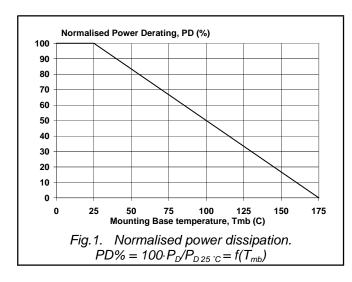
REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

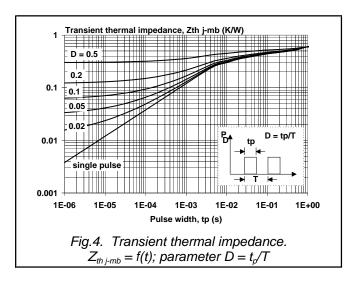
 $T_i = 25^{\circ}C$ unless otherwise specified

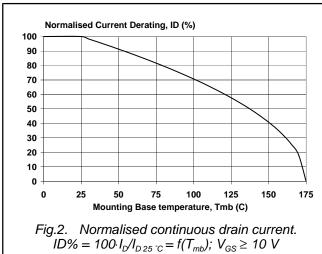
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _S	Continuous source current (body diode)		-	-	39	Α
I _{SM}	Pulsed source current (body diode)		-	-	156	Α
V_{SD}	Diode forward voltage	$I_F = 25 \text{ A}; V_{GS} = 0 \text{ V}$	-	0.85	1.2	V
t _{rr} Q _{rr}	Reverse recovery time Reverse recovery charge	$I_F = 20 \text{ A}; -dI_F/dt = 100 \text{ A}/\mu\text{s};$ $V_{GS} = 0 \text{ V}; V_R = 30 \text{ V}$	-	133 895		ns nC

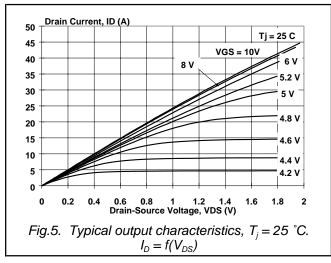
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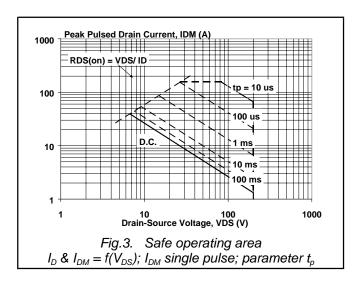
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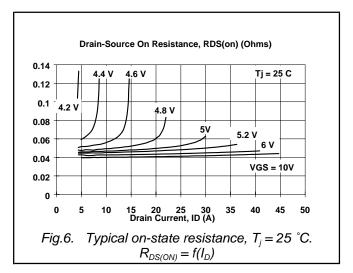






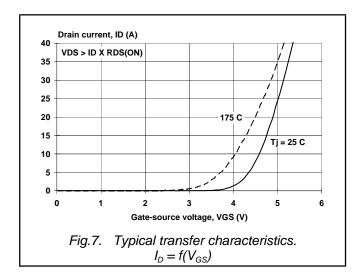


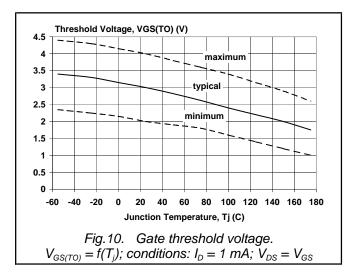


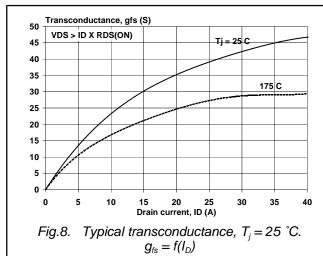


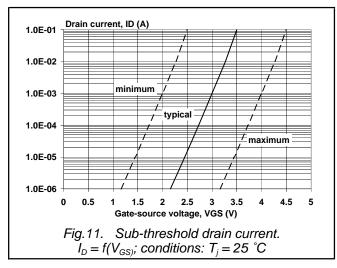
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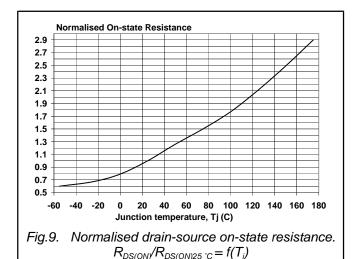
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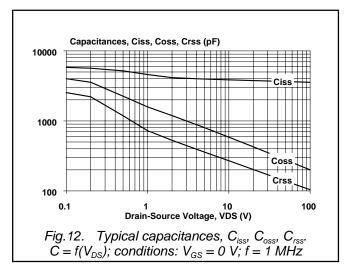












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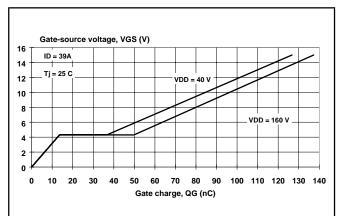


Fig.13. Typical turn-on gate-charge characteristics. $V_{\rm GS} = f(Q_{\rm G})$

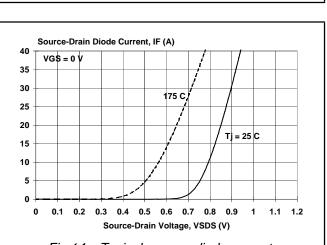


Fig.14. Typical reverse diode current. $I_F = f(V_{SDS})$; conditions: $V_{GS} = 0$ V; parameter T_j

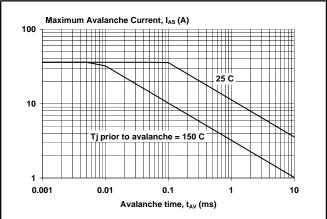


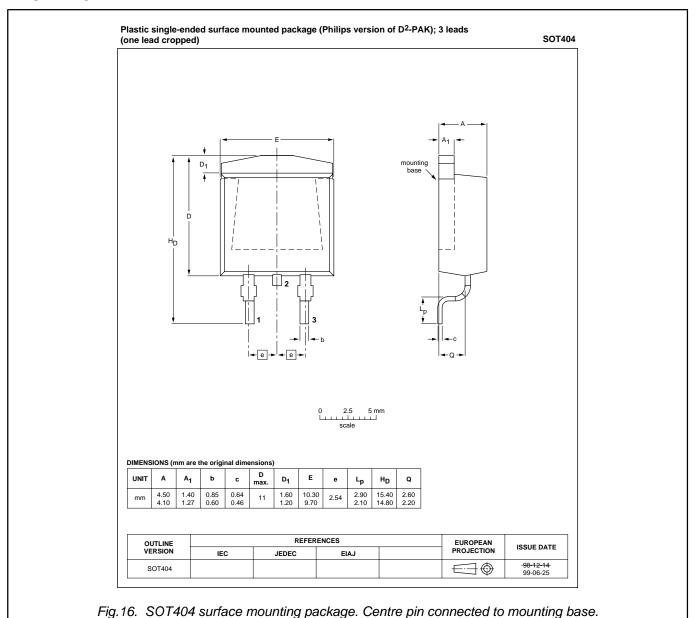
Fig.15. Maximum permissible non-repetitive avalanche current (I_{AS}) versus avalanche time (t_{AV}); unclamped inductive load

Silicon MAX

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MECHANICAL DATA



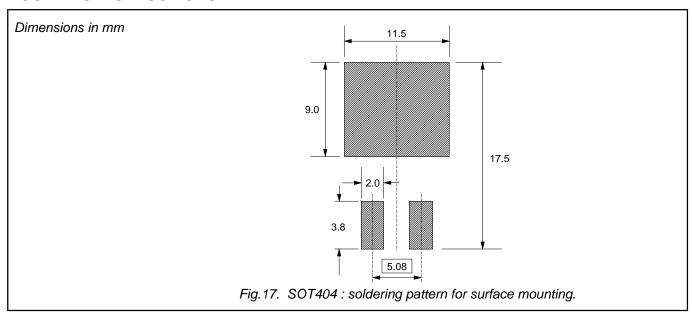
Notes

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
- 3. Epoxy meets UL94 V0 at 1/8".

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MOUNTING INSTRUCTIONS



DEFINITIONS

Data sheet status			
Objective specification This data sheet contains target or goal specifications for product development.			
Preliminary specification This data sheet contains preliminary data; supplementary data may be published la			
Product specification This data sheet contains final product specifications.			
Limiting values			

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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